

SA3280™ LED Chips

CxxxSA3280-Sxx00-x

PRODUCT DESCRIPTION

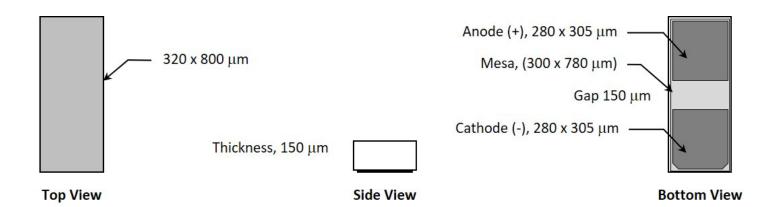
Cree LED's Direct Attach™ SA3280™ LED chips are the next generation of solidstate LED emitters that combine highly efficient InGaN materials with Cree LED's proprietary device technology to deliver superior value for the general illumination and automotive exterior markets. The SA3280 LED chips are among the brightest in the market at a low forward voltage, resulting in a very bright and highly efficient solution. The bondpad-down design allows for eutectic die attach, eliminating the need for wire bonds, enabling superior performance, improved thermal management and high reliabilty. The design is optimally suited for industrystandard top-view packages.

FEATURES

- Direct Attach™ LED Technology, no wire bonding
- · High Reliability Flux Eutectic Attach
- Junction-Down design minimizes $R_{\rm th}$ for Improved Thermal Management
- · Direct Attach LED RF Performance:
 - 450 nm 180+ mW
 - Low Forward Voltage (V₁)
 - 3.0 V Typical at 150 mA
- Maximum DC Current (I_f) 250 mA
- · AuSn bond pad metal for Eutectic Attach
- · 2000 V, Class 2 ESD Rating

APPLICATIONS

- · General Illumination
 - White LEDs
 - Chip-on-Board (COB)
 - Multi-chip Arrays
 - High Voltage Arrays
- Automotive
 - Interior Lighting
 - Exterior Indicators



CPR3JN REV 1



MECHANICAL SPECIFICATIONS

Description	Dimension	Tolerance
P-N Junction Area (μm) - reference only	(300 x 780)	-
Chip Top Area (µm)	320 x 800	±25
Chip Bottom Area (µm)	320 x 800	±25
Chip Thickness (µm)	150	±15
Bond Pad - Anode (µm) - reference only	(280 x 305)	-
Bond Pad - Cathode (µm) - reference only	(280 x 305)	-
Bond Pad Gap (µm) - reference only	(150)	-
Bond Pad Thickness (µm) - AuSn, reference only	(3.0)	-

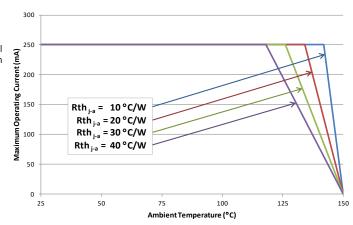
MAXIMUM RATINGS & TYPICAL CHARACTERISTICS

Maximum Ratings at T _A = 25°C Note 1	CxxxSA3280-Sxx00-x
DC Forward Current Note 4	250 mA
Peak Forward Current (10% Duty Cycle @ 1 kHz)	350 mA
LED Junction Temperature	150°C
Reverse Voltage Note 6	5 V
Operating Temperature Range	-40°C to +120°C
LED Chip Storage Temperature Range (LED Chip storage only, not for Die Sheet Storage)	-40°C to +120°C
Recommended Die Sheet Storage Conditions	≤30°C / ≤85% RH
Electrostatic Discharge Threshold (HBM) Note 2	2000 V
Electrostatic Discharge Classification (MIL-STD-883K) Note 2	Class 2

Typical Electrical/Optical Charact						
Part Number	For	rward Voltage (V	., V)	Reverse Current [I(Vr=5 V), μΑ]	Full Width Half Max (λ _p , nm)	
	Min.	Тур.	Max.	Max.	Тур.	
C450SA3280-Sxx00-x	2.8	3.0	3.2	1	19	

Notes:

- 1. Maximum ratings are package-dependent. The above ratings were determined using an encapsulated SMT package for characterization. Ratings for other packages may differ. The forward currents (DC and Peak) are limited by the LED junction temperature in the package. The junction temperature should be characterized in a specific package to determine limitations. Assembly processing temperature must not exceed 325°C (< 5 seconds).
- Product resistance to electrostatic discharge (ESD) according to the HBM is performed on each die. The ESD classification is based on sample testing according to MIL-STD-883K.
- 3. All products conform to the listed minimum and maximum specifications for electrical and optical characteristics when assembled and operated at the binning current within the maximum ratings shown above. Efficiency decreases at higher currents. Typical values given are within the range of average values expected by the manufacturer in large quantities and are provided for information only. All measurements were made using a Au-plated TO header without an encapsulant.
- 4. The maximum forward current is determined by the thermal resistance between the LED junction and ambient. The end-product design should minimizes the thermal resistance (R_{th}) from the LED junction to ambient in order to optimize product performance.
- 5. Specifications are subject to change without notice.
- 6. Continuous reverse voltage can cause LED damage.





STANDARD BINS

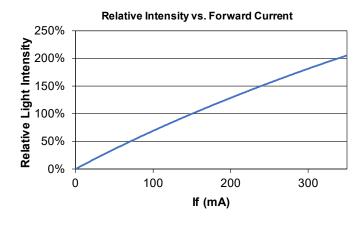
LED chips are sorted to the Radiant Flux (RF) and Dominant Wavelength (DW) bins shown below. A sorted die sheet contains die from only one bin. Sorted die kit (CxxxSA3280-Sxx00-x) orders may be filled with any or all bins (CxxxSA3280-xxxx-x) contained in the kit. All RF and DW values are measured on bare die at If = 150 mA.

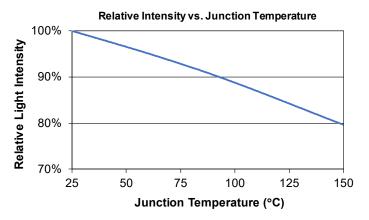
C452SA3280-S18000-x 220 Radiant Flux (mW) C450SA3280-xxxx-x C450SA3280-xxxx-x C450SA3280-xxxx-x C450SA3280-xxxx-x C460SA3280-xxxx-x C460SA3280-xxxx-x 210 C450SA3280-xxxx-x C450SA3280-xxxx-x C450SA3280-xxxx-x C450SA3280-xxxx-x C460SA3280-xxxx-x C460SA3280-xxxx-x 200 C450SA3280-xxxx-x C450SA3280-xxxx-x C450SA3280-xxxx-x C450SA3280-xxxx-x C460SA3280-xxxx-x C460SA3280-xxxx-x 190 C450SA3280-xxxx-x C450SA3280-xxxx-x C450SA3280-xxxx-x C450SA3280-xxxx-x C460SA3280-xxxx-x C460SA3280-xxxx-x 180 450 452.5 445 447.5 455 457.5 460

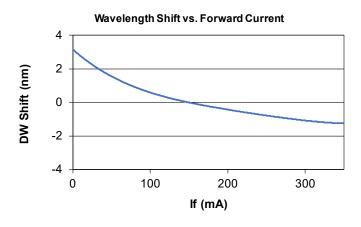


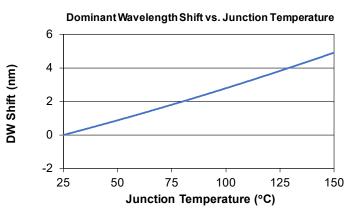
CHARACTERISTIC CURVES

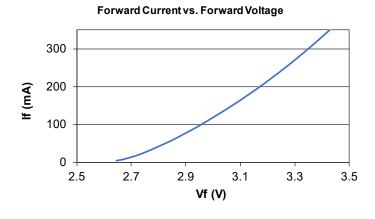
These are representative measurements for the SA LED product. Actual curves will vary slightly for the various radiant flux and dominant wavelength bins.

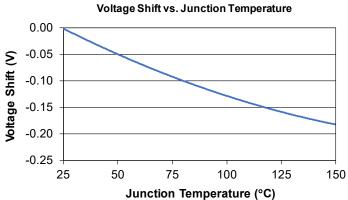








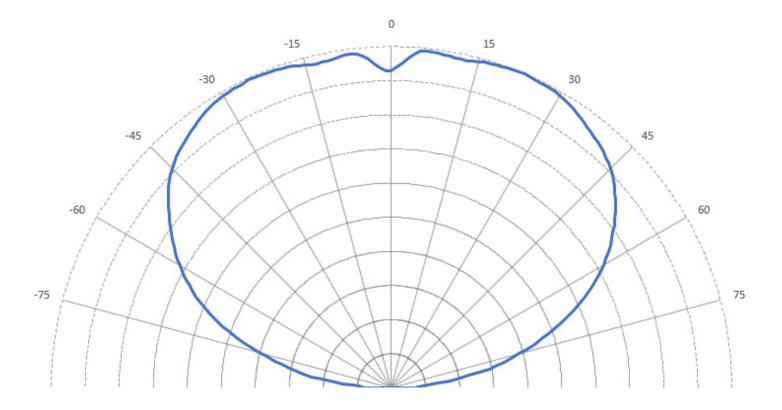






RADIATION PATTERN

This is a representative radiation pattern for the SA LED product. Actual patterns will vary slightly for each chip.





PRODUCT CONTENT INFORMATION AND WARNINGS

This information is not intended as legal advice. Consult a qualified lawyer if you are unfamiliar with the applicability of China RoHS 2 and/or California Proposition 65 to your business and products.

China RoHS 2



This green "e" logo is included on this product datasheet to indicate that the Cree LED product described herein does not include any of chemicals regulated under China RoHS 2 above permissible threshold limits. As applicable, each customer that incorporates this Cree LED product into its higher-level product needs to decide on the appropriate China RoHS 2 label for its higher-level product based on any other regulated content used in its product. If no other regulated content is present, this green "e" logo also may be used for the customer's product.

Pursuant to Management Methods for Restricted Use of Hazardous Substances in Electrical and Electronic Products, an administrative order published by the Chinese Ministry of Industry and Information Technology (MIIT) and effective as of July 1, 2016 (more commonly known as "China RoHS 2"), electronic and electrical end products (EEPs) sold into China must be marked with a logo to indicate whether or not they contain any of the chemicals regulated under China RoHS 2 (i.e., lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls, or polybrominated diphenyl ethers) above the permissible threshold limits. As of March 2018, the list of EEPs includes refrigerators, air conditioners, washing machines, water heaters, printers, copiers, fax machines, TV sets. monitors, microcomputers, cell phones, and telephones. This list is subject to modification by the MIIT.

According to MIIT guidance, suppliers supporting the manufacture of EEPs (i.e., component suppliers) may—but are not required to—include a label on their component products. However, if a component product includes one of the regulated substances, the component supplier must provide the purchaser with information in a prescribed tabular format to facilitate labeling EEPs. The table must disclose the type and location of the hazardous substances contained in the component product. If a component product that could be used in an EEP is sold separately in the market, the component product falls within the scope of China RoHs unless the final purpose is known to be out of scope. A supplier that does not directly sell products in China should nevertheless comply with China RoHS 2 if there is a possibility that its products or products incorporating its products will be sold in China. For more information about China RoHS, please refer to http://www.chinarohs.com/docs.html.

California Proposition 65 Warnings

This Cree LED semiconductor die product (excluding packaging) does not contain any chemicals that must be disclosed under California Proposition 65 (officially titled the Safe Drinking Water and Toxic Enforcement Act of 1986, codified at Cal. Health & Saf. Code §§ 25249.5–.13) enacted by the State of California. This die product, however, is packaged using PVC die transfer film that contains Diisononyl Phthalate (DINP), a chemical known to the State of California to cause cancer and/or birth defects or other reproductive harm. If you are located in the State of California, the presence of DINP in the PVC die transfer film results in the need for you to provide an occupational warning under Proposition 65. Pursuant to California Health and Safety Code § 25606, you must post Proposition 65 compliant warnings at your place(s) of business in California to warn your employees and contractors who may come into contact with the PVC die transfer film during use and handling of the Cree LED die products, including in connection with the development or manufacture of higher-level products. Specifically, for indoor environments or outdoor spaces with clearly defined entrances, a warning sign must be posted at all public entrances to the affected area and, in no smaller than 72-point type, read substantially as follows:



WARNING: Entering this area may expose you to Diisononyl Phthalate (DINP), a chemical known to the State of California to cause cancer and birth defects or other reproductive harm. DINP is present in the PVC die transfer film on which certain semiconductor die products sold by CreeLED, Inc. or one of its affiliates are delivered. Please refer to the Cree LED website at www.cree-led.com/about/suppliers-contractors/prop-65 to verify which Cree LED semiconductor die products are delivered on this type of PVC die transfer film. For more information on California's Proposition 65 warnings, go to www.P65Warnings.ca.gov.

This occupational warning must be provided in English and in any other language used on other signage in the affected area. Since the Cree LED die products themselves do not contain DINP, their incorporation into your products will not create an obligation for you to include a Proposition 65 warning on your products. Please insure ensure that the PVC die transfer film is properly handled and properly disposed of as a hazardous material after die

Please refer to the Cree LED website at www.cree-led.com/about/suppliers-contractors/prop-65 to verify which Cree LED semiconductor die products are delivered on this type of PVC die transfer film.